SECA Stack Test Fixture Development and Implementation

Y.S. Chou, J.W. Stevenson, Z.G. Yang, G.G. Xia, K.S. Weil, J.P. Choi, J.D. Templeton, K.P. Recknagle, M.A. Khaleel, and P. Singh

Pacific Northwest National Laboratory Richland, WA 99352

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Presentation Outline

- Conclusions
- Background
- Objectives
- Approach
- ▶ Test Fixture Design & Assembly
- Implementation: Test Results
- Future Work
- Conclusions
- Acknowledgements



Conclusions/Accomplishments

- A stack test fixture based on 50mm x 50mm cells (40mm x 40mm cathode) has been developed for evaluation/validation of new materials, fabrication processes, and design concepts.
- Implementation:
 - Performance of refractory glass seals has been validated.
 - Seals exhibited excellent performance during 25 deep thermal cycles
 - Current emphasis is on evaluation/validation of low-cost interconnect alloys and cathode-side interconnect modifications:
 - AISI 441 ferritic stainless steel
 - Ce-MnCo spinel coatings for exposed interconnect surfaces
 - Aluminization of sealing surfaces
- Working to improve performance and reproducibility
 - Minimize "hand-crafted" aspects of assembly; replace with "automated" assembly processes
- Developing revised fixture design
 - Consistent with future available thicknesses of AISI 441 (coil purchased from ATI Allegheny Ludlum by SECA program)
 - Multiple cell capability (3 cells or more)
- Transferring test capability to NETL



Background

- SECA Core Program Testing at Sub-stack Level
 - Materials Characterization
 - XRD, SEM, EDS, TEM, XPS, TGA, DSC, PSA, dilatometry, electrical conductivity, single & dual atmosphere oxidation
 - Multiple Component Tests
 - Button cell testing
 - ASR testing of interconnect/cathode contact/cathode structures
 - Electrical testing and leak testing of seal/interconnect and cell/seal/interconnect structures
- Next Step: Testing under realistic "stack-like" conditions
 - Advantage: Higher degree of relevance to SECA Industry Team cells/stacks
 - Challenges:
 - Multiple components & phenomena, so results more difficult to interpret
 - Increased complexity of assembly, co-fabrication of seals and electrical contact materials



Objectives

- Develop SOFC stack test fixture for SECA Core Technology Program (CTP)
- Evaluate/validate new materials and fabrication processes under realistic stack conditions
 - Larger cell size (≥50mm x ≥50mm)
 - Complete stack functionality (cell, cell frame, seals, interconnects, electrical contact materials)
- Share fixture design with other SECA participants
 - Easy to assemble and test; Minimal fabrication cost
- Accelerate technology transfer from SECA CTP to SECA Industry Teams
 - Bridge the gap between small-scale CTP tests (e.g., button cells) and SECA industry team stacks

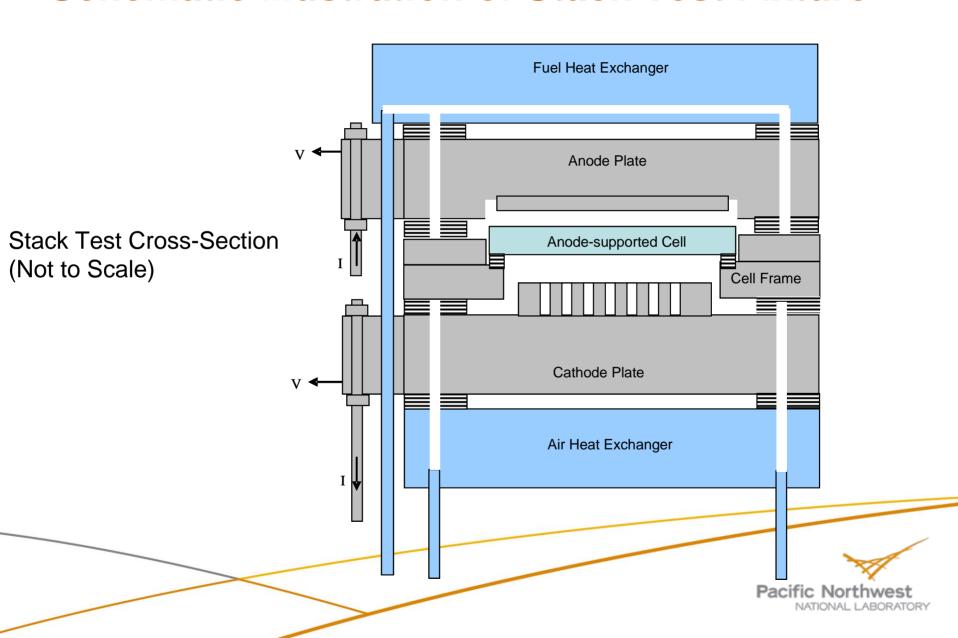


Approach

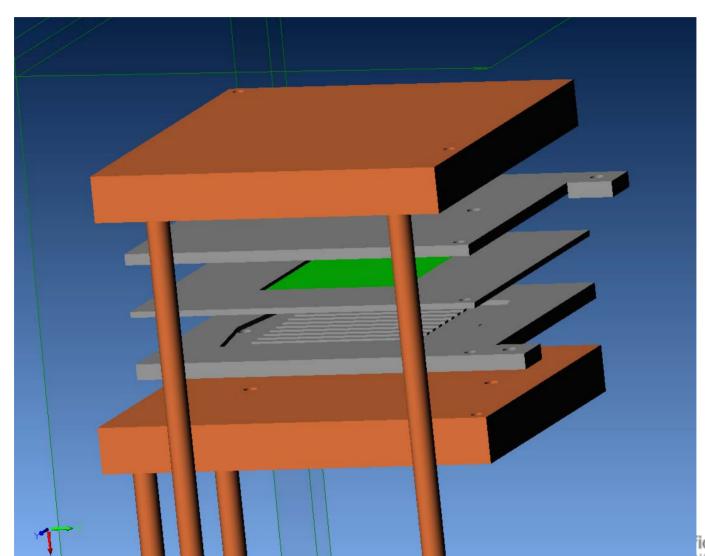
- Design
 - Initial fixture design provided by LBNL and NETL
 - Design modified by PNNL to incorporate cell-in-frame design concept, both cell-to-frame and perimeter seals, alternative flow path geometries. Iterative design approach i.e., results from previous tests used to identify design limitations
- Current Implementation
 - Parts
 - Cells purchased from H.C. Starck (InDEC)
 - ◆ 50 mm x 50 mm ASC3 anode-supported cells; LSM/YSZ cathode; ~\$200 each
 - Other components (interconnects, cell frame, seals, contact pastes) fabricated at PNNL
 - AISI 441 stainless steel provided by Allegheny Technologies, Inc.
 - Assembly and testing at PNNL
 - Electrochemical performance evaluation via I-V and EIS analysis
 - Post-test analysis via optical microscopy, XRD, SEM, EDS, TEM, XPS, etc
 - Compare stack results with results from tests on individual materials and substack structures, as well as modeled results



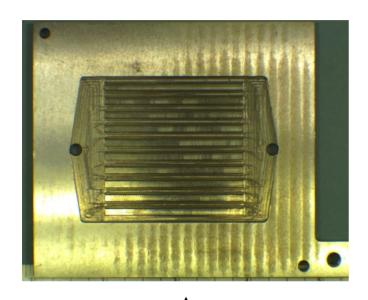
Schematic Illustration of Stack Test Fixture



Scale Drawing of Counter-Flow Test Fixture



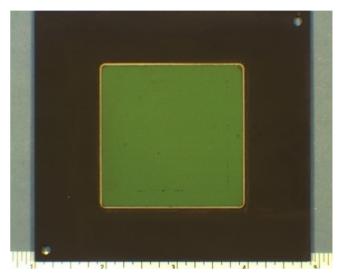
Stack Test Fixture Components

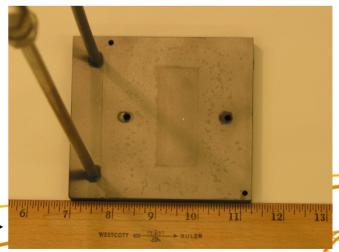


Anode interconnect plate (SS441)

Cell sealed in "window frame" (SS441) w/ refractory glass

Air heat exchanger (Inconel 600)





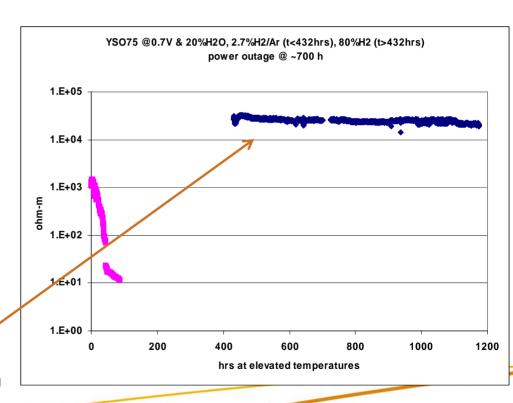
Implementation of Stack Fixture Tests

- Selected Test Results
 - Seal validation
 - Refractory glass seals tested under thermal cyclic conditions
 - Evaluation of low-cost steel interconnects with protective coatings
 - Simultaneous testing of spinel-coated and aluminized alloy surfaces



SECA CTP Stack Test Fixture: Refractory Glass Seal Evaluation

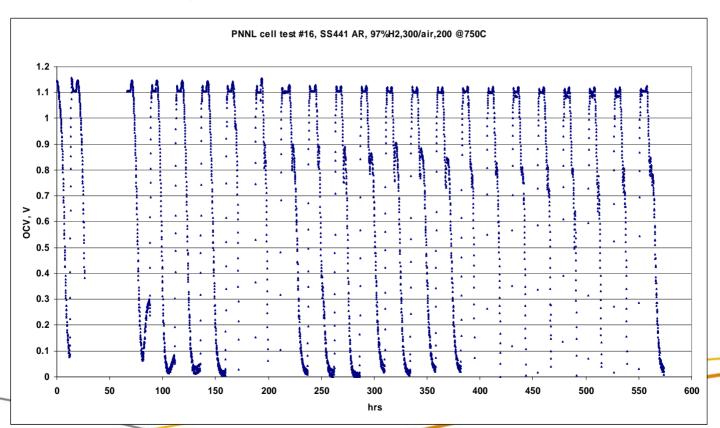
- Refractory sealing glasses ---Compositional modifications to G18 glass have resulted in:
 - Excellent wetting/sealing behavior to YSZ and interconnect alloys at 950-1000°C
 - Potentially improves electrical conductivity and strength of cathode/interconnect contacts
 - Rapid de-vitrification and stabilization of polycrystalline phases
 - Stable, matching CTE (11.5-12.5 ppm/°C; stable CTE up to 2,000 hours testing)
 - Improved chemical stability at operating temperatures
 - Stable, high electrical resistance in contact with steel interconnect (up to 1,200 hours testing)





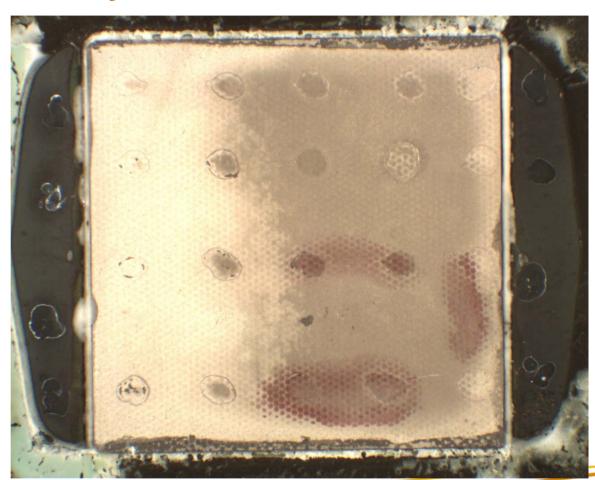
SECA CTP Stack Test Fixture: Refractory Glass Seal Evaluation

Cell with refractory glass seal demonstrated stable OCV during 25 deep thermal cycles (RT – 750°C)



SECA CTP Stack Test Fixture: Refractory Glass Seal Evaluation - Post-test Analysis

- Cell-to-frame glass seal remained intact (no dye penetration)
- Refractory glass selected as baseline seal composition for stack fixture testing





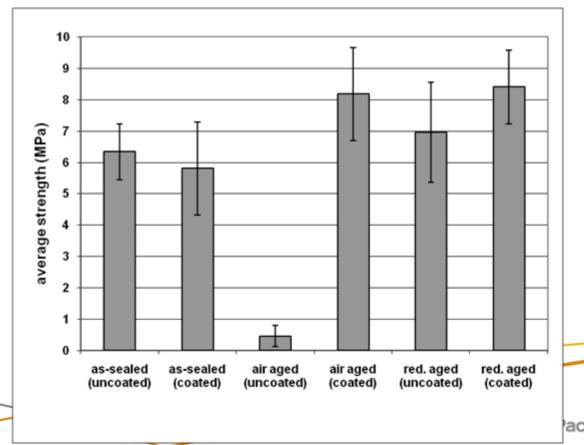
Evaluation of Low-Cost Steel Interconnects with Protective Surface Coatings

- ► Interconnect Components:
 - AISI 441 stainless steel
 - Pros: Inexpensive, matching CTE, easy to fabricate, conductive Cr-based scale, no SiO₂ subscale layer
 - Cons: Oxidation leads to increased electrical resistance, poor scale adherence, Cr volatility, reaction with glass seals
 - Ce-modified MnCo Spinel Coating
 - Reduces oxidation rate, improves scale adherence, mitigates Cr volatility
 - Aluminization
 - Mitigates reaction with glass seals

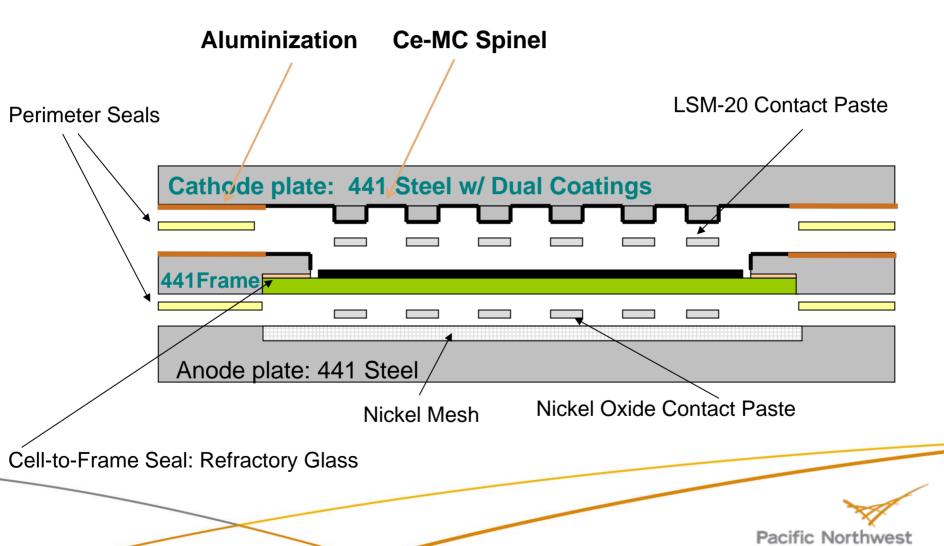


Evaluation of Low-Cost Steel Interconnects with Protective Surface Coatings

- Aluminization of alloy surface
 - Mitigates chromate formation, which degrades strength of seal



Evaluation of Low-Cost Steel Interconnects with Protective Surface Coatings



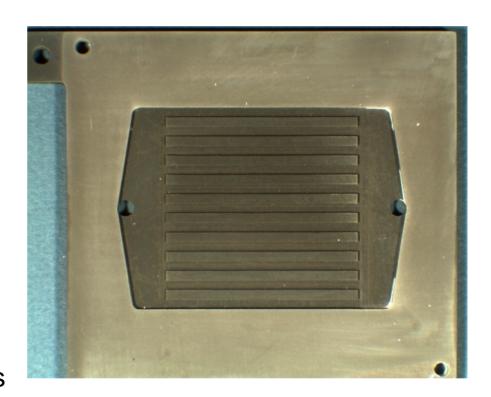
Evaluation of Low-Cost Steel Interconnects with Protective Surface Coatings

Dual Coatings

- Ce-MnCo spinel application to surfaces exposed to air
- Aluminization of sealing surfaces

Aluminization

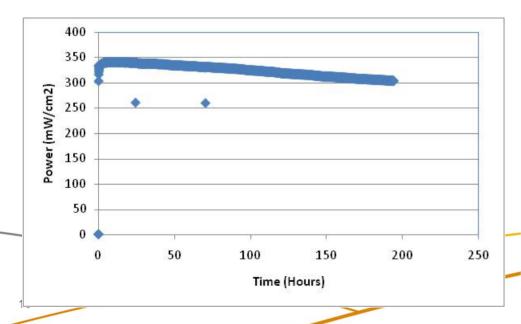
- Commercial processes also available from vendors, but challenging when dealing with small quantities of parts
- New aluminization process under development at PNNL

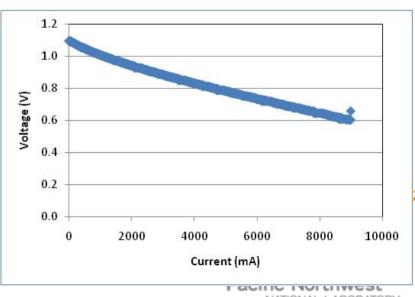




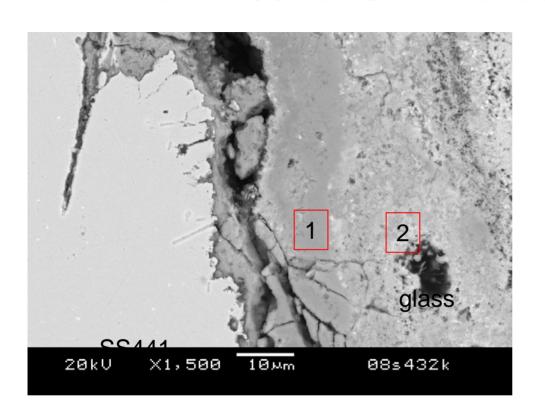
Evaluation of Low-Cost Steel Interconnects with Protective Surface Coatings - Results

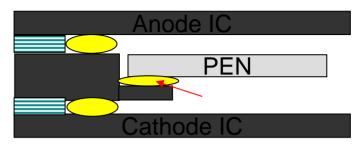
- First test
 - Good OCV, but poor electrical performance
 - Test was held at 800°C for 400 hours under OCV conditions
 - Post-test structural/chemical analysis performed by SEM/EDS
- Second test
 - Off to good start, but aborted by building power failure
- Third test
 - In progress
 - Plan to run for 1000 hours, then perform post-test analysis





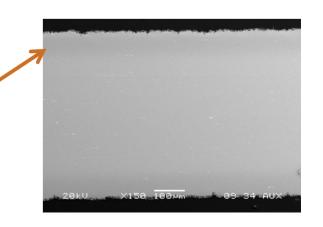
Aluminized 441/Glass Seal Interface



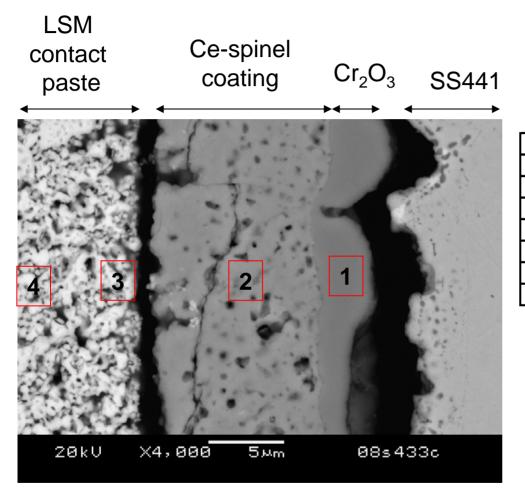


point	1	2
0	35.0	39.2
Al	1.1	5.0
Si	1.6	11.2
Ti	0.5	
Cr	41.8	16.1
Mn	1.1	
Fe	17.4	15.2
Cu	0.9	
Sr	0.6	8.6
Mg		0.7
Y		1.1
Ва		2.9

- •Aluminized SS441 frame / glass seal after 404h @ 800°C
- •Cr transport from the alloy observed, possibly due to non-uniform aluminized interface
- •Uniform coatings have been obtained in previous work with oxidizing treatment only
- •May be consequence of double heat treatment required for dual coating of parts
- Optimization of dual coating process in progress



Spinel-coated 441/LSM Contact Paste Interface



point	1	2	3	4
0	37.7	30.1	31.2	32.0
Ti	1.5	0.4		
Mn		37.7	31.6	33.8
Co		31.8	5.1	
Cr	60.8			
Sr			5.8	6.7
La			26.3	27.5

- •Ce-modified spinel-coated section of SS441 interconnect after 404h @ 800°C
- Results similar to substack testing (ASR tests)
- Effective blocking of Cr by spinel coating

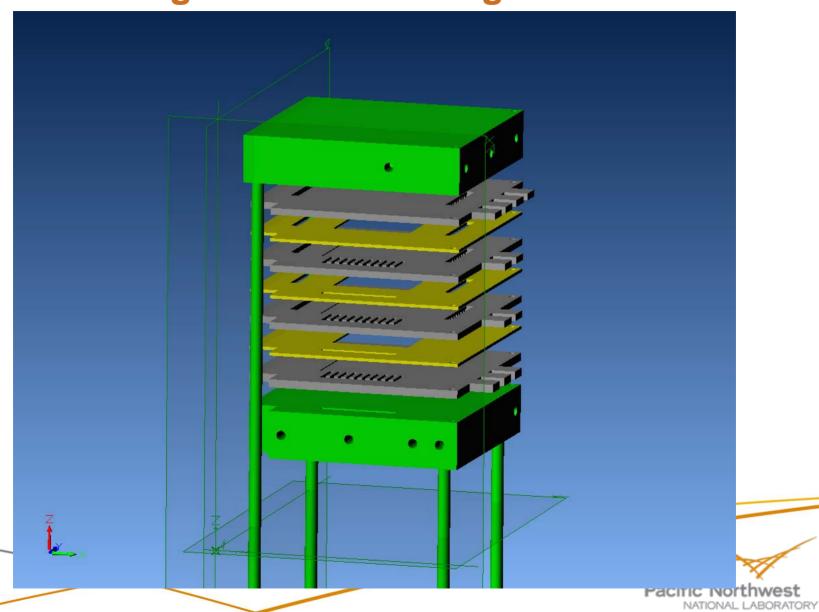


Changes in alloy availability

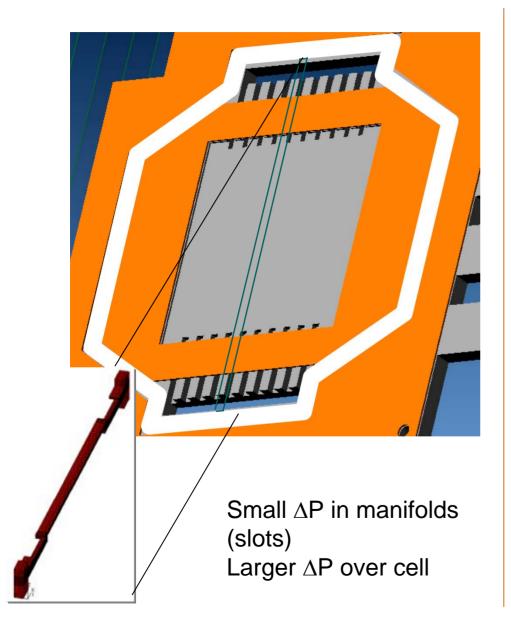
- Current design is based on 0.175" and 0.060" thick 441 sheet
 - 0.175" no longer available
- SECA program is acquiring large stock of 441 for use by SECA participants
 - 0.133", 0.040", 0.020", and 0.010" sheet
- Developing new fixture design consistent with available sheet thicknesses
 - Lower mass design closer replica of real stacks under development
 - Simpler component shapes (less machining, lower fabrication cost)
 - Multi-cell stack capability (3-cell stack tests planned)

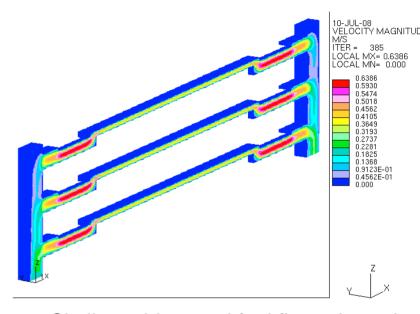


Scale Drawing of Revised Design: 3 Cell Stack



Modeling of Flow Distribution in 3-cell Stack





- Similar oxidant and fuel flows through three cells
- Flow distribution summary:

Percent of Mean Flow				
F	uel	Air		
Cell 3	99.7	99.72		
Cell 2	99.93	99.92		
Cell 1	100.37	100.36		

 Flow on both anode and cathode sides within +- 0.4% of meanthwest

Future Work

Design

- Transition to revised, reduced-mass stack fixture
 - Single cell tests
 - Multi-cell tests
- Continue to improve performance and reproducibility
 - Issues related to simultaneous fabrication of stack seals & contact materials
 - Minimize "hand-crafted" aspects; replace with "automated" processes
- Transfer stack test capability to NETL

Implementation

- Complete initial evaluation of interconnect materials system: 441 steel with Ce-modified MnCo spinel and alumina coatings
- Continue to evaluate/validate new materials/processes/design concepts. Candidates include:
 - Contact materials
 - Novel processing approaches (atmospheric cycling)
 - Novel materials (sintering aids, reaction sintering approaches)
 - Examine role of high temperature sealing on contact structure and load distribution (validation of modeling results)
 - New cathode materials
 - New interconnect alloys/coatings
 - Commercial cells



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- Additional PNNL contributors: Gary Maupin, Jared Templeton, Kerry Meinhardt, Jim Coleman, Shelley Carlson, Nat Saenz

